

# **AUIPS7111S**

### **CURRENT SENSE HIGH SIDE SWITCH**

#### **Features**

- Suitable for 24V systems
- Over current shutdown
- Over temperature shutdown
- Current sensing
- Active clamp
- Low current
- Reverse battery
- ESD protection
- Optimized Turn On/Off for EMI

#### **Applications**

24V loads for trucks

#### Description

The AUIPS7111S is a fully protected four terminal high side switch. It features current sensing, over-current, over-temperature, ESD protection and drain to source active clamp. When the input voltage Vcc - Vin is higher than the specified threshold, the output power Mosfet is turned on. When the Vcc - Vin is lower than the specified Vil threshold, the output Mosfet is turned off. The Ifb pin is used for current sensing.

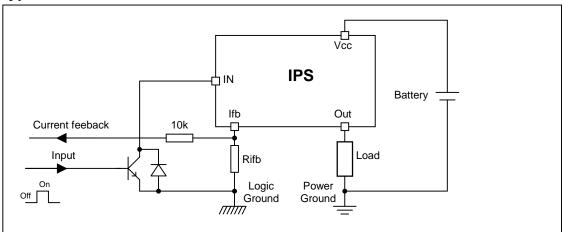
### **Product Summary**

Rds(on) 7.5 m $\Omega$  max. Vclamp 65V Current shutdown 30A min.

#### **Package**



### **Typical Connection**





### **Qualification Information**<sup>†</sup>

Qualification information							
Qualification Level		Automotive (per AEC-Q100 <sup>††</sup> )					
		Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.					
Moisture Sensitivity Level		D2PAK-5L	MSL1, 260°C (per IPC/JEDEC J-STD-020)				
	Machine Model		Class M3 (300V) (per AEC-Q100-003)				
ESD	Human Body Model		H2 (2,500 V) C-Q100-002)				
Charged Device Model		Class C4 (1000 V) (per AEC-Q100-011)					
IC Latch-Up Test			II, Level A C-Q100-004)				
RoHS Compliant		Yes					

<sup>†</sup> Qualification standards can be found at International Rectifier's web site <a href="http://www.irf.com/">http://www.irf.com/</a>

<sup>††</sup> Exceptions to AEC-Q100 requirements are noted in the qualification report.



**Absolute Maximum Ratings**Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. (Tj= -40°C..150°C,

Vcc=8..50V unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units
Vout	Maximum output voltage	Vcc-60	Vcc+0.3	V
Vcc-Vin max.	Maximum Vcc voltage	-32	60	V
Ifb, max.	Maximum feedback current	-50	10	mΑ
Pd	Maximum power dissipation (internally limited by thermal protection)			W
Fu	Tambient=25°C, Tj=150°C Rth=50°C/W D²Pack 6cm² footprint	_	2.5	VV
Tj max.	Max. storage & operating junction temperature	-40	150	°C

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
Rth1	Thermal resistance junction to ambient D <sup>2</sup> Pak Std footprint	60	_	
Rth2	Thermal resistance junction to ambient D <sup>2</sup> pak 6cm <sup>2</sup> footprint		_	°C/W
Rth3	Thermal resistance junction to case D²pak	0.8	_	

# Recommended Operating Conditions These values are given for a quick design.

Symbol	Parameter	Min.	Max.	Units
lout	Continuous output current, Tambient=85°C, Tj=125°C			۸
	Rth=40°C/W, D2pak 6cm2 footprint	_	10	А
Rifb		1.5	_	kΩ



#### **Static Electrical Characteristics**

Ti=-40\_150°C\_Vcc=8\_50V (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
Vcc op.	Operating voltage range	8	_	50	V		
Rds(on)	ON state resistance Tj=25°C	_	6	7.5	<b>~</b> 0	lds=10A	
	ON state resistance Tj=150°C	_	12	15	mΩ	IdS=TOA	
Icc off	Supply leakage current	_	2	6		Vin=Vcc=28V,Vifb=Vgnd	
lout off	Output leakage current	_	2	6	μA	Vout=Vgnd, Tj=25°C	
V clamp1	Vcc to Vout clamp voltage 1	60	65	_		Id=10mA	
V clamp2	Vcc to Vout clamp voltage 2	_	66	_	V	Id=10A see fig. 2	
Vih(2)	High level Input threshold voltage	_	5.5	6.8	\ \ \	Id=10mA	
Vil(2)	Low level Input threshold voltage	3.5	5	_			
Rds(on) rev	Reverse On state resistance Tj=25°C	_	7	10	mΩ	Isd=10A,	
	Reverse On state resistance Tj=150°C	_	13	18		Vcc-Vin=732V	
Vf	Forward body diode voltage Tj=25°C	_	0.75	0.8	V	If=10A	
	Forward body diode voltage Tj=125°C	_	0.6	0.65	V		
Rin	Internal input resistor	180	250	350	Ω	Tj=-40°C125°C	

<sup>(2)</sup> Input thresholds are measured directly between the input pin and the tab. See also page 6

#### **Switching Electrical Characteristics**

Vcc=28V. Resistive load=3O. Ti=25°C

700-201, 1100:0110 1044-011, 1j-20 0							
Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
tdon	Turn on delay time to 20%	25	35	50	110		
tr	Rise time from 20% to 80% of Vcc	8	17	25	μs	See fig. 1	
tdoff	Turn off delay time	50	80	120		See lig. 1	
tf	Fall time from 80% to 20% of Vcc	5	13	35	μs		

#### **Protection Characteristics**

Tj=-40..150°C, Vcc=8..50V (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Tsd	Over temperature threshold	150(3)	165	_	°C	See fig. 3 and fig. 10
Isd	Over-current shutdown	30	45	60	Α	See fig. 3 and page 7
I fault	Ifb after an over-current or an over-temperature (latched)	2.4	4	6	mA	See fig. 3

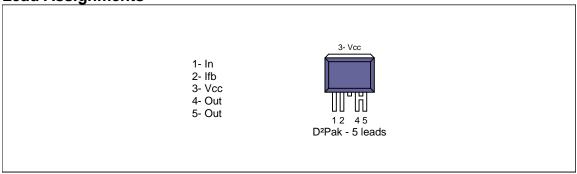
# **Current Sensing Characteristics** Tj=-40..150°C, Vcc=8..50V (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ratio	I load / Ifb current ratio	11000	13000	14500		lout=10A
Ratio_TC	I load / Ifb variation over temperature	-5%	0	+5	%	
I offset	Load current offset	-0.25	0	0.25	Α	lout<10A
Ifb leakage	Ifb leakage current on	0	6	15	μΑ	lout=0A, Tj=25°C

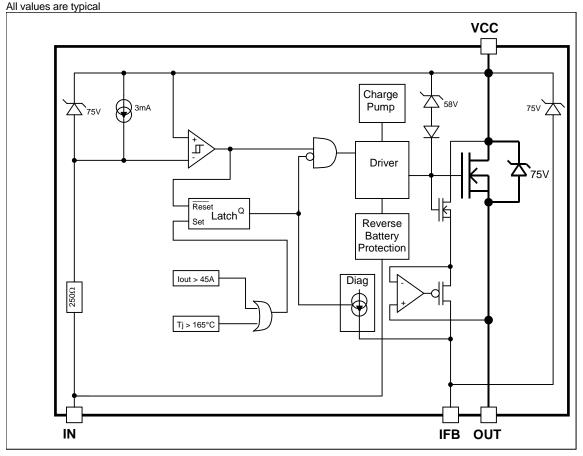
<sup>(3)</sup> Guaranteed by design



**Lead Assignments** 



# Functional Block Diagram All values are typical





#### **Truth Table**

On One differen	Laurent	0	10
Op. Conditions	Input	Output	Ifb pin voltage
Normal mode	Н	L	0V
Normal mode	L	Н	I load x Rfb / Ratio
Open load	Н	L	0V
Open load	L	Н	Ifb leakage x Rifb
Short circuit to GND	Н	L	0V
Short circuit to GND	L	L	I fault x Rifb (latched)
Over temperature	Н	L	0V
Over temperature	L	L	I fault x Rifb (latched)

### **Operating voltage**

Maximum Vcc voltage: this is the maximum voltage before the breakdown of the IC process.

**Operating voltage**: This is the Vcc range in which the functionality of the part is guaranteed. The AEC-Q100 qualification is run at the maximum operating voltage specified in the datasheet.

#### Reverse battery

During the reverse battery the Mosfet is turned on if the input pin is powered with a diode in parallel of the input transistor. Power dissipation in the IPS:  $P = Rdson rev * I load^2 + Vcc^2 / 250$  (internal input resistor).

If the power dissipation I too hight in Rifb, a diode in serial can be added to block the current.

### **Active clamp**

The purpose of the active clamp is to limit the voltage across the MOSFET to a value below the body diode break down voltage to reduce the amount of stress on the device during switching.

The temperature increase during active clamp can be estimated as follows:

$$\Delta_{\mathsf{Tj}} = \mathsf{P}_{\mathsf{CL}} \cdot \mathsf{Z}_{\mathsf{TH}}(\mathsf{t}_{\mathsf{CLAMP}})$$

Where:  $Z_{TH}(t_{CLAMP})$  is the thermal impedance at  $t_{CLAMP}$  and can be read from the thermal impedance curves given in the data sheets.

 $\boldsymbol{P}_{\!CL} = \boldsymbol{V}_{\!CL} \cdot \boldsymbol{I}_{\!CLavg}$  : Power dissipation during active clamp

$$V_{\scriptscriptstyle CL} = 39 V$$
 : Typical  $V_{\scriptscriptstyle CLAMP}$  value

$$I_{CLavg} = \frac{I_{CL}}{2}$$
: Average current during active clamp

$$t_{CL} = \frac{I_{CL}}{\left|\frac{di}{dt}\right|} : Active clamp duration$$

$$\frac{di}{dt} = \frac{V_{Battery} - V_{CL}}{L} : Demagnetization current$$

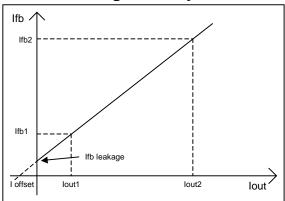
Figure 9 gives the maximum inductance versus the load current in the worst case : the part switch off after an over temperature detection. If the load inductance exceed the curve, a free wheeling diode is required.



#### Input level VIH/VIL

The input level are referenced to Vcc. When Vcc-Vin exceed VIH the part turns on and when Vcc-Vin goes below VIL the part turns off

#### **Current sensing accuracy**



The current sensing is specified by measuring 3 points :

- Ifb1 for lout1
- Ifb2 for lout2
- Ifb leakage for lout=0

The parameters in the datasheet are computed with the following formula:

Ratio = (lout2 - lout1)/(lfb2 - lfb1)

I offset = Ifb1 x Ratio - Iout1

This allows the designer to evaluate the lfb for any lout value using:

Ifb = ( lout + I offset ) / Ratio if Ifb > Ifb leakage

For some applications, a calibration is required. In that case, the accuracy of the system will depends on the variation of the I offset and the ratio over the temperature range. The ratio variation is given by Ratio\_TC specified in page 4.

The loffset variation depends directly of the Rdson:

I offset@-40°C= I offset@25°C / 0.7

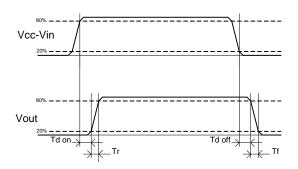
I offset@150°C= I offset@25°C / 1.9

#### **Over-current protection**

The threshold of the over-current protection is set in order to guaranteed that the device is able to turn on a load with an inrush current lower than the minimum of lsd. Nevertheless for high current and high temperature the device may switch off for a lower current due to the over-temperature protection (see Figure 10).

## **AUIPS7111S**





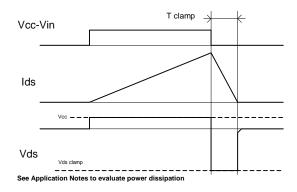


Figure 1 – IN rise time & switching definitions

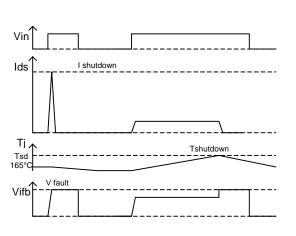


Figure 3 - Protection timing diagram

Figure 2 - Active clamp waveforms

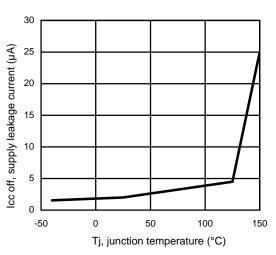


Figure 4 – Icc off (µA) Vs Tj (°C)



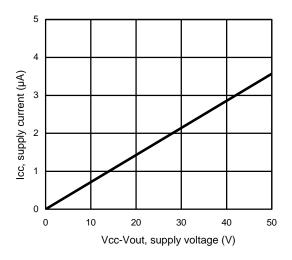


Figure 5 - Icc Off(µA) Vs Vcc-Vout (V)

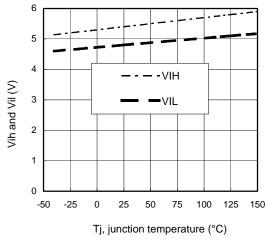


Figure 6 - Vih and Vil (V) Vs Tj (°C)

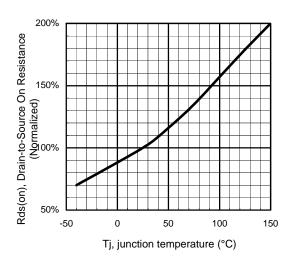


Figure 7 - Normalized Rds(on) (%) Vs Tj (°C)

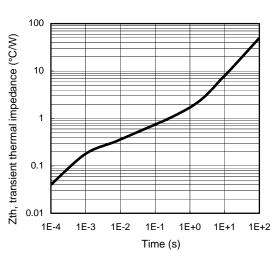
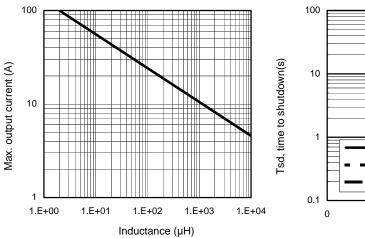


Figure 8 – Transient thermal impedance (°C/W) Vs time (s)





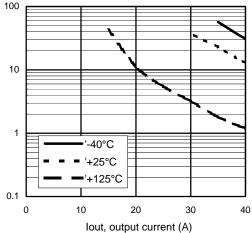
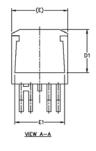


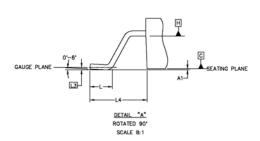
Figure 9 - Max. lout (A) Vs inductance (µH)

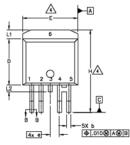
Figure 10 – Tsd (s) Vs I out (A) SMD with 6cm<sup>2</sup>

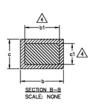


#### Case Outline D2PAK - 5 Leads



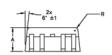






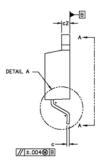
Ň.			N I			
M B O L	MILLIM	ETERS	INC	HES	O T E	
Ĺ	MIN.	MAX.	MIN.	MAX.	S	
Α	4.06	4.83	.160	.190		
A1		0.254		.010		
ь	0.66	0.91	.026	.036	4	
ь1	0.66	0.81	.026	.032		
c	0.38	0.74	.015	.029		
c1	0.38	0.58	.015	.023	4	
c2	1.14	1.65	.045	.065		
D	8.51	9.65	.335	.380	3	
D1	6.86		.270			
Ε	9.65	10.67	.380	.420	3	
E1	6.22		.245			
е	1.70	BSC	.067	BSC		
н	14.73	15.49	.580	.609		
L	1.14	1.39	.045	.055		
L1		1.65		.065		
L2	1.27	1.78	.050	.070		
L3	0.25	BSC	.010	BSC		
L4	4.78	5.28	.188	.208		
m	17.78		.700			
m1	8.89		.350			
n	11.43		.450			
٥	1.93		.076			
р	3.81		.150			
R	0.51	0.71	.020	.028		

DIMENSIONS





FOOT PRINT SCALE 2:1



#### NOTES:

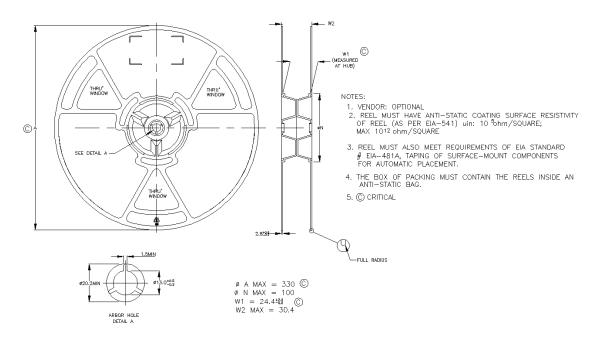
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.

4. DIMENSION 61 AND 61 APPLY TO BASE METAL ONLY.

- 5. CONTROLLING DIMENSION: MILLIMETERS
- 6. LEADS AND DRAIN ARE PLTED WITH 100% Sn

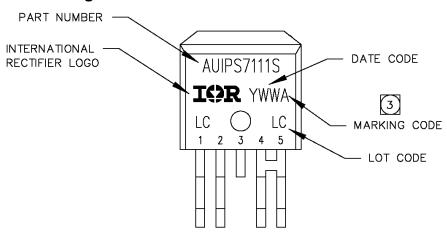


### Tape & Reel D2PAK - 5 Leads





## **Part Marking Information**



# **Ordering Information**

Base Part Number	Darles en Terre	Standard Pack	Complete Dort Number	
base i ait ivuilibei	Package Type	Form	Quantity	Complete Part Number
		Tube	50	AUIPS7111S
AUIPS7111R	D2-Pak-5-Leads	Tape and reel left	800	AUIPS7111STRL
		Tape and reel right	800	AUIPS7111STRR



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